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High-Voltage - High Power Transistors

High-voltage - high power transistors designed for use in high power audio amplifier applications and high voltage switching regulator circuits.

• High Collector Emitter Sustaining Voltage –

 $V_{CEO(sus)} = 140 \text{ Vdc}$

• High DC Current Gain – @ $I_C = 8.0$ Adc

 $h_{FE} = 15 \text{ (Min)}$

• Low Collector-Emitter Saturation Voltage -

 $V_{CE(sat)} = 1.0 \text{ Vdc (Max)} @ I_C = 10 \text{ Adc}$

MAXIMUM RATINGS (1)

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	140	Vdc
Collector-Base Voltage	V _{CB}	140	Vdc
Emitter-Base Voltage	V _{EB}	7.0	Vdc
Collector Current - Continuous Peak	I _C	16 20	Adc
Base Current – Continuous	Ι _Β	5.0	Adc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	200 1.14	W W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +200	°C

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16 AMPERE
POWER TRANSISTORS
COMPLEMENTARY SILICON
140 VOLTS, 200 WATTS



CASE 1-07 TO-204AA (TO-3)

THERMAL CHARACTERISTICS (1)

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	θ_{JC}	0.875	°C/W

(1) Indicates JEDEC Registered Data.

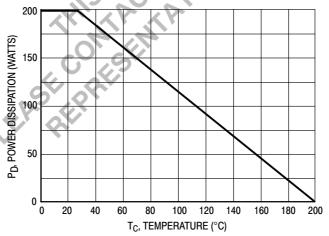


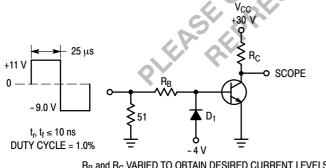
Figure 1. Power Derating

Safe Area Curves are indicated by Figure 5. All Limits are applicable and must be observed.

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS			<u> </u>	•	
Collector-Emitter Sustaining Voltage (2) (I _C = 200 mAdc, I _B = 0)		V _{CEO(sus)}	140	_	Vdc
Collector-Emitter Cutoff Current (V _{CE} = 70 Vdc, I _B = 0)		I _{CEO}			mAdc
			-	2.0	
Collector–Emitter Cutoff Current (V_{CE} = Rated V_{CB} , $V_{EB(off)}$ = 1.5 Vdc) (V_{CE} = Rated V_{CB} , $V_{EB(off)}$ = 1.5 Vdc, T_{C} = 150°C)		I _{CEX}	- -	2.0 7.0	mAdc
Collector-Base Cutoff Current $(V_{CB} = Rated V_{CB}, I_E = 0)$		I _{CBO}	-	2.0	mAdc
Emitter-Base Cutoff Current (V _{BE} = 7.0 Vdc, I _C = 0)		I _{EBO}	_	5.0	mAdc
ON CHARACTERISTICS (2)					
DC Current Gain ($I_C = 8$ Adc, $V_{CE} = 2.0$ Vdc) ($I_C = 16$ Adc, $V_{CE} = 2.0$ Vdc)		h _{FE}	15 4.0	60 -	-
Collector–Emitter Saturation Voltage ($I_C = 10$ Adc, $I_B = 1.0$ Adc) ($I_C = 16$ Adc, $I_B = 4.0$ Adc)		V _{CE(sat)}	- -	1.0 2.0	Vdc
Base–Emitter Saturation Voltage ($I_C = 10$ Adc, $I_B = 1.0$ Adc)		V _{BE(sat)}	-	1.8	Vdc
Base-Emitter On Voltage (I _C = 8.0 Adc, V _{CE} = 2.0 Vdc)		V _{BE(on)}	-	1.5	Vdc
DYNAMIC CHARACTERISTICS					
Current-Gain - Bandwidth Product (3) (I _C = 1.0 Adc, V _{CE} = 20 Vdc, f _{test} = 0.5 MHz)		f _T	1.0	_	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 0.1 MHz)	2N5631 2N6031	C _{ob}	- -	500 1000	pF
Small-Signal Current Gain (I _C = 4.0 Adc, V _{CE} = 10 Vdc, f = 1.0 kHz)		h _{fe}	15	_	-

⁽²⁾ $f_T = |h_{fe}| \cdot f_{test}$



 $\ensuremath{\mathsf{R}}_B$ and $\ensuremath{\mathsf{R}}_C$ varied to obtain desired current levels D_1 MUST BE FAST RECOVERY TYPE, e.g.: 1N5825 USED ABOVE $I_B \approx 100 \ mA$ MSD6100 USED BELOW I_B ≈ 100 mA

For PNP test circuit, reverse all polarities and D1.

Figure 2. Switching Times Test Circuit

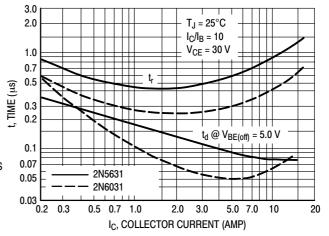


Figure 3. Turn-On Time

^{*}Indicates JEDEC Registered Data.
(1) Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≥ 2.0%

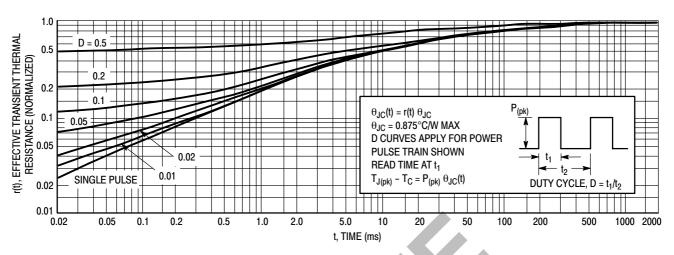


Figure 4. Thermal Response

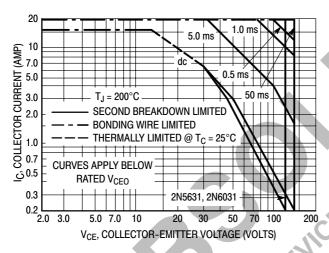
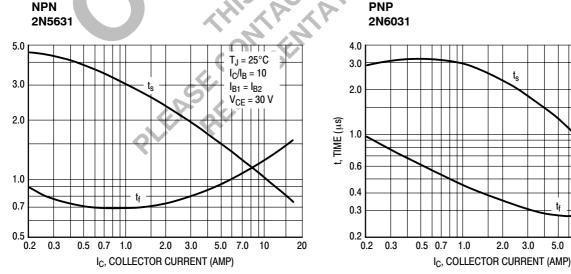


Figure 5. Active-Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C - V_{CE} limits of the transistor that must be observed for reliable operation, i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on $T_{J(pk)} = 200$ °C; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided T_{J(pk)} ≤ 200 °C. $T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.



 $I_{B1} = I_{B2}$ $I_{C}/I_{B} = 10$ $V_{CE} = 30 \text{ V}$ 2.0 3.0 7.0 20

 $T_J = 25^{\circ}C$

Figure 6. Turn-Off Time

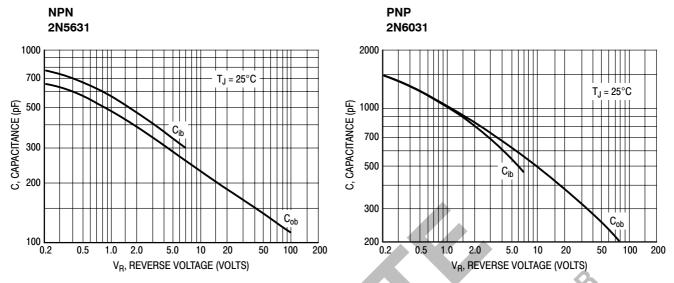
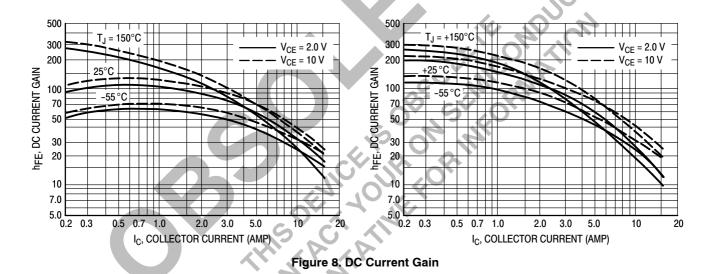


Figure 7. Capacitance



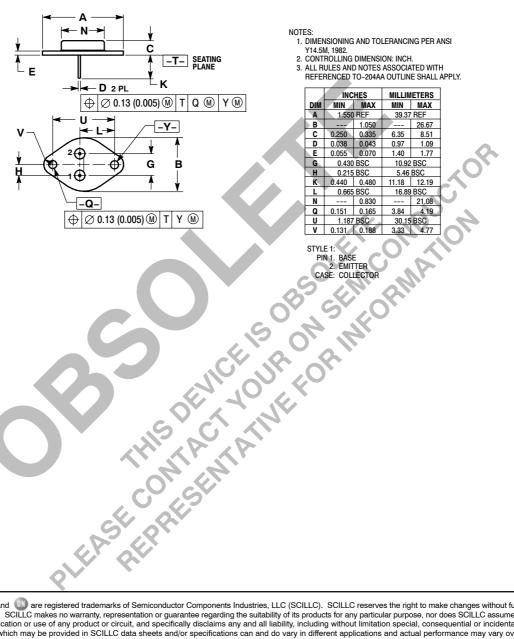
V_{CE}, COLLECTOR-EMITTER VOLTAGE (VOLTS) V_{CE}, COLLECTOR-EMITTER VOLTAGE (VOLTS) $T_J = 25^{\circ}C$ $T_J = 25^{\circ}C$ 1.6 $I_C = 4.0 A$ $I_C = 4.0 \text{ A}$ 1.2 8.0 A 8.0 A 16 A 0.8 0.8 0.4 0.05 0.07 0.1 0.3 0.5 0.7 2.0 3.0 0.05 0.07 0.1 0.3 2.0 3.0 0.2 1.0 5.0 0.2 0.5 0.7 5.0 IB, BASE CURRENT (AMP) IB, BASE CURRENT (AMP)

Figure 9. Collector Saturation Region

2N5631

PACKAGE DIMENSIONS

CASE 1-07 TO-204AA (TO-3) **ISSUE Z**



NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14 5M 1982
- 2. CONTROLLING DIMENSION: INCH.
 3. ALL RULES AND NOTES ASSOCIATED WITH REFERENCED TO-204AA OUTLINE SHALL APPLY.

	INCHES MILLIMETER			IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	1.550 REF		39.37 REF		
В		1.050		26.67	
С	0.250	0.335	6.35	8.51	
D	0.038	0.043	0.97	1.09	
E	0.055	0.070	1.40	1.77	
G	0.430	BSC	10.92 BSC		
H	0.215	BSC	5.46 BSC		
K	0.440	0.480	11.18	12.19	
L	0.665 BSC		16.89 BSC		
N		0.830		21.08	
Q	0.151	0.165	3.84	4.19	
U	1.187 BSC		30.15 BSC		
٧	0.131	0.188	3.33	4.77	

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